## $\square$ MN102H46 Series

| Type | MN102H460B |
| :--- | :---: |
| Internal ROM type | External |
| ROM (byte) | - |
| RAM (byte) | 4 K |
| Package (Lead-free) | LQFP128-P-1818C, TQFP128-P-1414B |
| Minimum Instruction <br> Execution Time | [With main clock operated] |

## Interrupts

/RST pin, Watchdog, /NMI pin, Timer counter 4 to15, Timer counter 16, Timer counter 17, Timer counter 21, Timer counter 16 to 20 compare capture A, Timer counter 16 to 20 compare capture B, Timer counter 21 capture A, Timer counter 21 capture B, Timer counter 21 capture D, Timer counter 21 compare E, Timer counter 21 compare F, ATC ch. 0 to ch. 3 transfer finish, External 0 to 7, Serial ch. 0 to ch. 3 transmission, Serial ch. 0 to ch. 3 reception, /KI pin (OR), A/D conversion finish

## Timer Counter

8 -bit timer $\times 16$
Timer 0,1 ...............prescalers
Timer 2, 3 ..............UART baud rate generator
Timer 4 ..................timer output, A/D conversion start up
Timer 5, $9 \ldots . . . . . . . . . . . . U A R T$ baud rate generator
Timer 6 to 8 ...........timer output
Timer 10 to 15 .......timer output
[Connectable] timer counter 0 to 3,4 to 7,8 to 11,12 to 15
16 -bit timer $\times 5$
Timer 16 to 20 .......timer output, event count, input capture, output compare, PWM output, 2-phase encorder inpu
24 -bit timer $\times 1$
Timer 21. $\qquad$ .servo control

## Serial interface

Serial 0,1:8-bit $\times 1$ (transfer direction of MSB / LSB selectable, transmission / reception of 7, 8-bit length)
Serial 2, 3:8-bit $\times 1$ (transfer direction of MSB / LSB selectable, transmission / reception of 7, 8-bit length)
UART $\times 4$ (common use with serial 0 to 3 )
$\mathrm{I}^{2} \mathrm{C} \times 2$ (common use with serial 1,3 ; single master)

- I/O Pins

I/O 55 : Common use : 55 (use of full address, address data separate 16-bit mode)
Input 8: Common use :8

## A/D converter

10 -bit $\times 12$-ch. (maximum input is 16 ) (with $\mathrm{S} / \mathrm{H}$ )
PWM
16-bit $\times 5$-ch. (timer counter 16 to 20)

- ICR

16 -bit $\times 5$-ch., 24 -bit $\times 1$-ch. (timer counter 16 to 21 )

- OCR

16 -bit $\times 5$-ch., 24 -bit $\times 1$-ch. (timer counter 16 to 21 )

## Notes

Address / data multiplex bus interface, address / data separate bus interface,
8 -bit / 16 -bit bus width selectable

Electrical Charactreistics (Supply current)

| Parameter | Symbol | Condition | Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min | typ | max |  |
| Operating supply current | IDDopr | VI = VDD or VSS, output open $\mathrm{f}=40 \mathrm{MHz}, \mathrm{VDD}=3.3 \mathrm{~V}$ |  |  | 50 | mA |
| Supply current at STOP | IDDS | Pin with pull-up resistor is open all other input pins and $\mathrm{Hi}-\mathrm{Z}$ state input/output pins are simultaneously applied VDD or VSS level$\mathrm{f}=40 \mathrm{MHz}, \mathrm{VDD}=3.3 \mathrm{~V} \text {, output open }$ |  |  | 50 | $\mu \mathrm{A}$ |
| Supply current at HALT | IDDH |  |  |  | 25 | mA |

$\left(\mathrm{Ta}=-20^{\circ} \mathrm{C}\right.$ to $\left.+70^{\circ} \mathrm{C}, \mathrm{VDD}=\mathrm{AVDD}=3.3 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSS}=0 \mathrm{~V}\right)$

## Development tools

In-circuit Emulator
PX-ICE102H46-LQFP128-P-1818C
PX-ICE102H46-TQFP128-P-1414B
Minimum instruction execution time $\quad 57.1 \mathrm{~ns}$ (at 30 MHz )
Pin Assignment
LQFP128-P-1818C, TQFP128-P-1414B


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